

0.8A, 200V - 1000V High Efficient Surface Mount Rectifier

FEATURES

- Glass passivated chip junction
- Ideal for automated placement
- Low profile package
- Moisture sensitivity level: level 1, per J-STD-020
- RoHS Compliant
- Halogen-free according to IEC 61249-2-21

APPLICATIONS

- DC to DC converter
- Switching mode converters and inverters
- Freewheeling application

MECHANICAL DATA

- Case: SOD-123W
- Molding compound meets UL 94V-0 flammability rating
- Terminal: Matte tin plated leads, solderable per J-STD-002
- Meet JESD 201 class 2 whisker test
- Polarity: Indicated by cathode band
- Weight: 0.016g (approximately)

| KEY PARAMETERS | | | |
|---------------------|------------|---|--|
| PARAMETER VALUE UNI | | | |
| I _F | 0.8 | А | |
| V _{RRM} | 200 - 1000 | V | |
| I _{FSM} | 20 | А | |
| T _{J MAX} | 150 °C | | |
| Package | SOD-123W | | |
| Configuration | Single die | | |





SOD-123W



| ABSOLUTE MAXIMUM RATINGS (T _A = 25°C unless otherwise noted) | | | | | | | |
|--|---------------------|--------------|-------|-------|-------|-------|------|
| PARAMETER | SYMBOL | HSDLW | HSGLW | HSJLW | HSKLW | HSMLW | UNIT |
| Marking code on the device | | HSDLW | HSGLW | HSJLW | HSKLW | HSMLW | |
| Repetitive peak reverse voltage | V_{RRM} | 200 | 400 | 600 | 800 | 1000 | V |
| Reverse voltage, total rms value | V _{R(RMS)} | 140 | 280 | 420 | 560 | 700 | V |
| Forward current | I _F | | | 0.8 | | | Α |
| Peak forward surge current, 8.3ms single half sine-wave superimposed on rated load | I _{FSM} | 20 | | | | A | |
| Junction temperature | TJ | - 55 to +150 | | °C | | | |
| Storage temperature | T _{STG} | - 55 to +150 | | | °C | | |



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| THERMAL PERFORMANCE | | | | |
|--|------------------|-----|------|--|
| PARAMETER | SYMBOL | ТҮР | UNIT | |
| Junction-to-lead thermal resistance | R _{ØJL} | 34 | °C/W | |
| Junction-to-ambient thermal resistance | R _{ÐJA} | 86 | °C/W | |
| Junction-to-case thermal resistance | R _{ejc} | 35 | °C/W | |

Thermal Performance Note: Units mounted on PCB (5mm x 5mm Cu pad test board)

| ELECTRICAL SPECIFICATIONS (T _A = 25°C unless otherwise noted) | | | | | | |
|--|-------------------------|--|-----------------|------|------|------|
| PARAMETER | | CONDITIONS | SYMBOL | ТҮР | MAX | UNIT |
| | HSDLW | $I_F = 0.4A, T_J = 25^{\circ}C$ | | 0.81 | 0.97 | V |
| | | I _F = 0.8A, T _J = 25°C | | 0.86 | 1.00 | V |
| | | $I_F = 0.4A, T_J = 125^{\circ}C$ | | 0.66 | 0.79 | V |
| | | $I_F = 0.8A, T_J = 125^{\circ}C$ | | 0.73 | 0.83 | V |
| | | $I_F = 0.4A, T_J = 25^{\circ}C$ | | 0.84 | 1.01 | V |
| (1) | | $I_F = 0.8A, T_J = 25^{\circ}C$ | | 0.91 | 1.30 | V |
| Forward voltage ⁽¹⁾ | HSGLW | $I_F = 0.4A, T_J = 125^{\circ}C$ | V _F | 0.70 | 0.83 | V |
| | | $I_F = 0.8A, T_J = 125^{\circ}C$ | | 0.77 | 1.05 | V |
| | | $I_F = 0.4A, T_J = 25^{\circ}C$ | | 1.17 | 1.40 | V |
| | HSJLW HSKLW HSMLW | $I_F = 0.8A, T_J = 25^{\circ}C$ | | 1.31 | 1.70 | V |
| | | $I_F = 0.4A, T_J = 125^{\circ}C$ | | 0.93 | 1.12 | V |
| | | $I_F = 0.8A, T_J = 125^{\circ}C$ | | 1.09 | 1.30 | V |
| (2) | | $T_J = 25^{\circ}C$ | | - | 1 | μA |
| Reverse current @ rated $V_R^{(2)}$ | | T _J = 125°C | I _R | - | 150 | μA |
| | HSDLW | | | 17 | - | pF |
| | HSGLW | 1MHz, V _R = 4.0V | | 14 | - | pF |
| Junction capacitance | HSJLW HSKLW HSMLW | | CJ | 5 | - | pF |
| Reverse recovery time | HSDLW HSGLW | I _F = 0.5A , I _R = 1.0A I _{rr} = 0.25A | | - | 50 | ns |
| | HSJLW HSKLW HSMLW | | t _{rr} | - | 75 | ns |

Notes:

1. Pulse test with PW = 0.3ms

2. Pulse test with PW = 30ms

| ORDERING INFORMATION | | | | |
|------------------------------|----------|----------------------|--|--|
| ORDERING CODE ⁽¹⁾ | PACKAGE | PACKING | | |
| HSxLW | SOD-123W | 10,000 / Tape & Reel | | |

Notes:

1. "x" defines voltage from 200V(HSDLW) to 1000V(HSMLW)



CHARACTERISTICS CURVES

(T_A = 25°C unless otherwise noted)

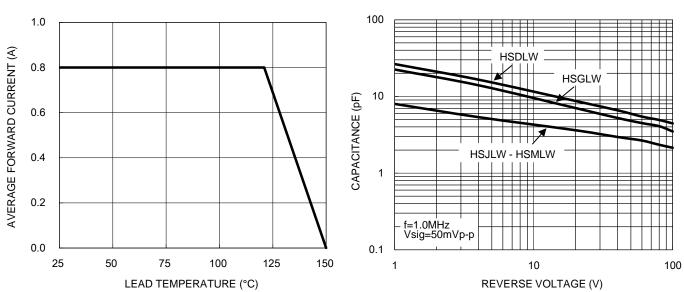


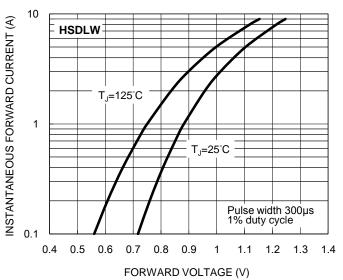
Fig.1 Forward Current Derating Curve

Fig.2 Typical Junction Capacitance

Fig.3 Typical Reverse Characteristics

1 INSTANTANEOUS REVERSE CURRENT (µA) HSDLW T_J=125°C 0.1 0.01 T,=25°C 0.001 100 10 20 30 40 50 60 70 80 90 PERCENT OF RATED PEAK REVERSE VOLTAGE (%)

Fig.4 Typical Forward Characteristics





CHARACTERISTICS CURVES

 $(T_A = 25^{\circ}C \text{ unless otherwise noted})$

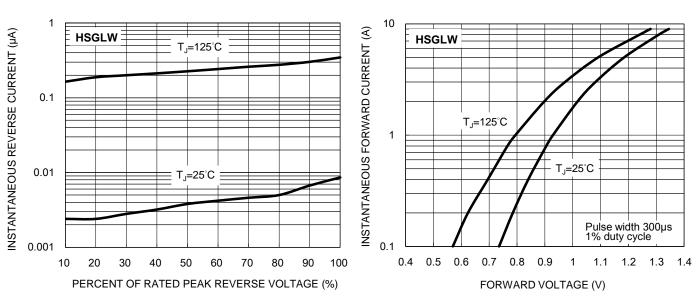


Fig.5 Typical Reverse Characteristics

Fig.6 Typical Forward Characteristics

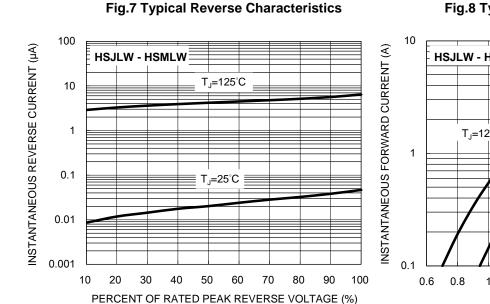
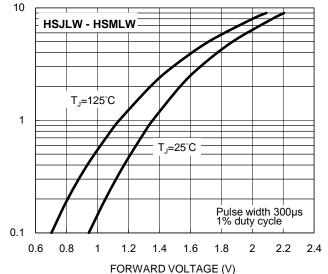
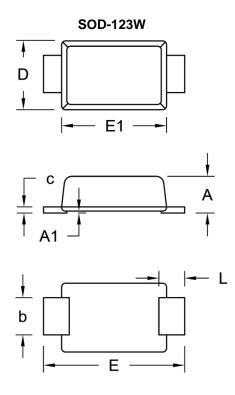


Fig.8 Typical Forward Characteristics



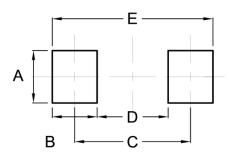
HSDLW – HSMLW Taiwan Semiconductor

PACKAGE OUTLINE DIMENSIONS



| DIM. | Unit (mm) | | Unit (inch) | | |
|------|-----------|------|-------------|-------|--|
| | Min. | Max. | Min. | Max. | |
| A | 0.90 | 1.02 | 0.035 | 0.040 | |
| A1 | 0.00 | 0.10 | 0.000 | 0.004 | |
| b | 0.90 | 1.05 | 0.035 | 0.041 | |
| с | 0.10 | 0.22 | 0.004 | 0.009 | |
| D | 1.70 | 1.90 | 0.067 | 0.075 | |
| Е | 3.60 | 3.80 | 0.142 | 0.150 | |
| E1 | 2.60 | 2.90 | 0.102 | 0.114 | |
| L | 0.50 | 0.85 | 0.020 | 0.033 | |

SUGGESTED PAD LAYOUT



| Symbol | Unit (mm) | Unit (inch) |
|--------|-----------|-------------|
| A | 1.40 | 0.055 |
| В | 1.20 | 0.047 |
| С | 3.10 | 0.122 |
| D | 1.90 | 0.075 |
| E | 4.30 | 0.169 |

MARKING DIAGRAM



P/N = Marking Code

YW = Date Code

F = Factory Code



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